

1/5

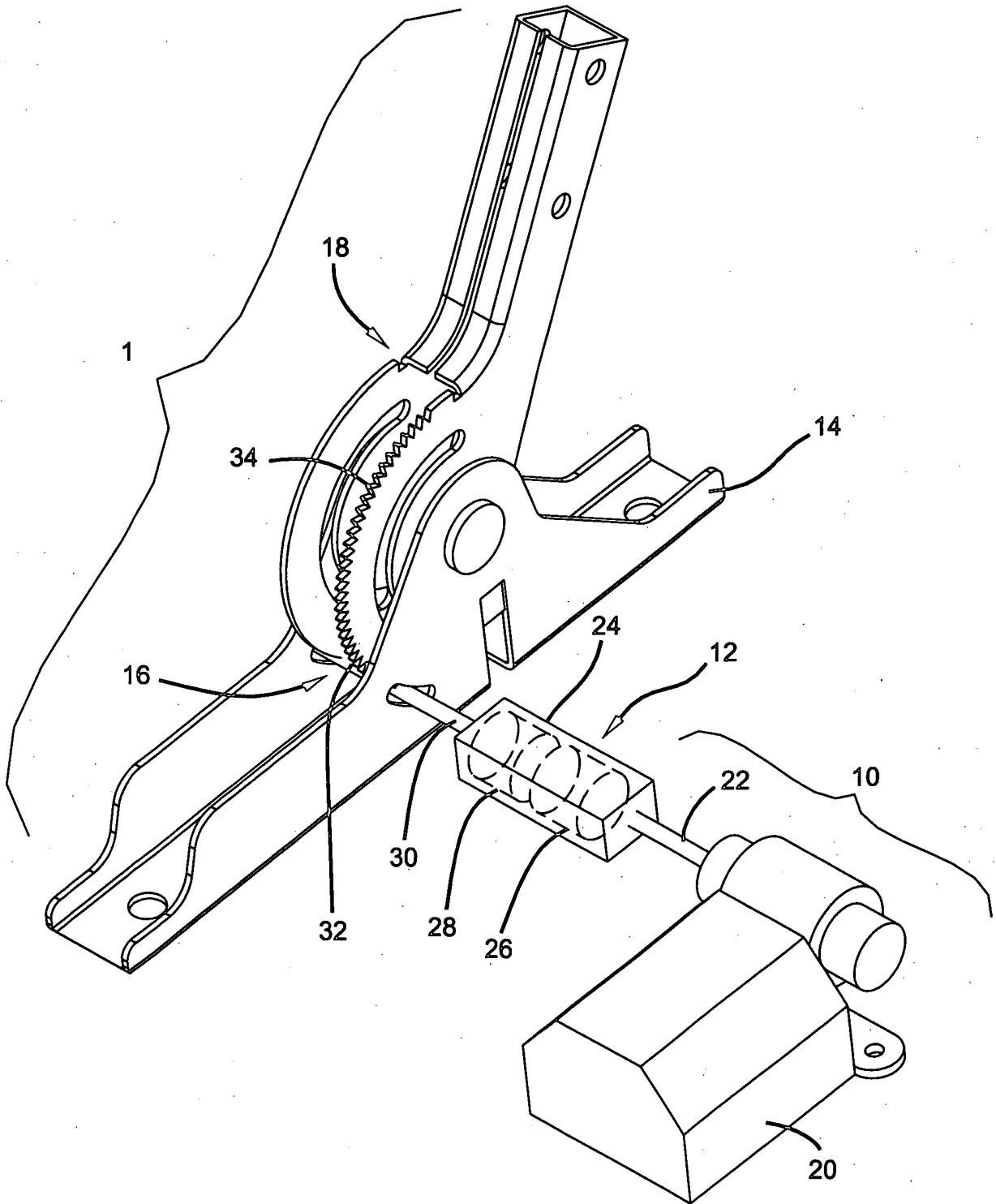


FIG 1

2/5

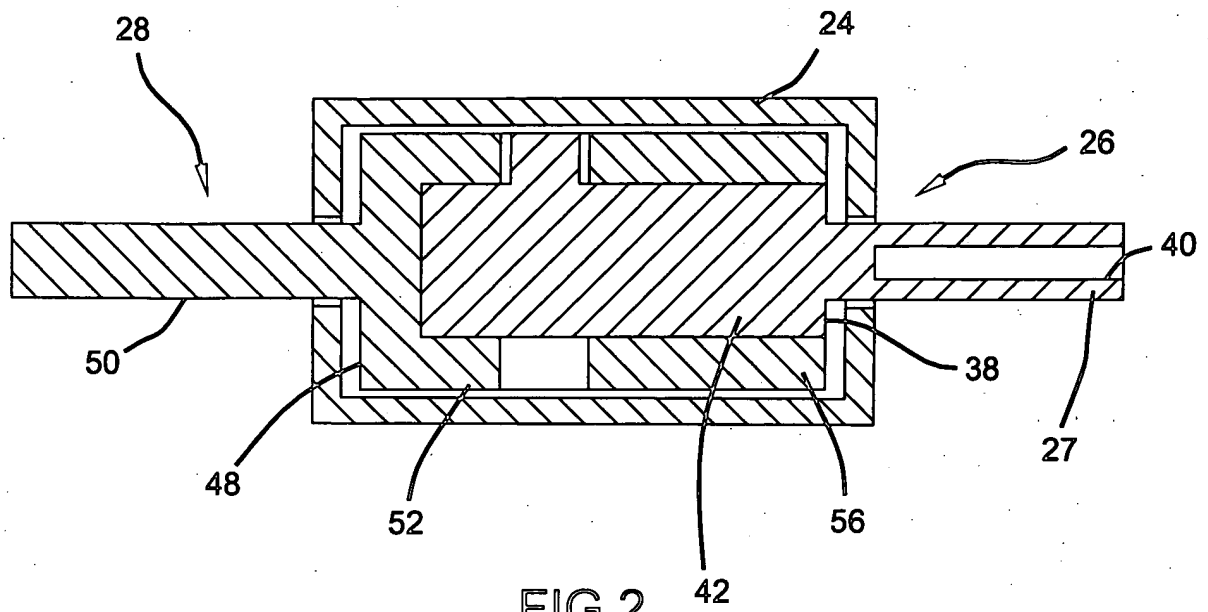


FIG 2

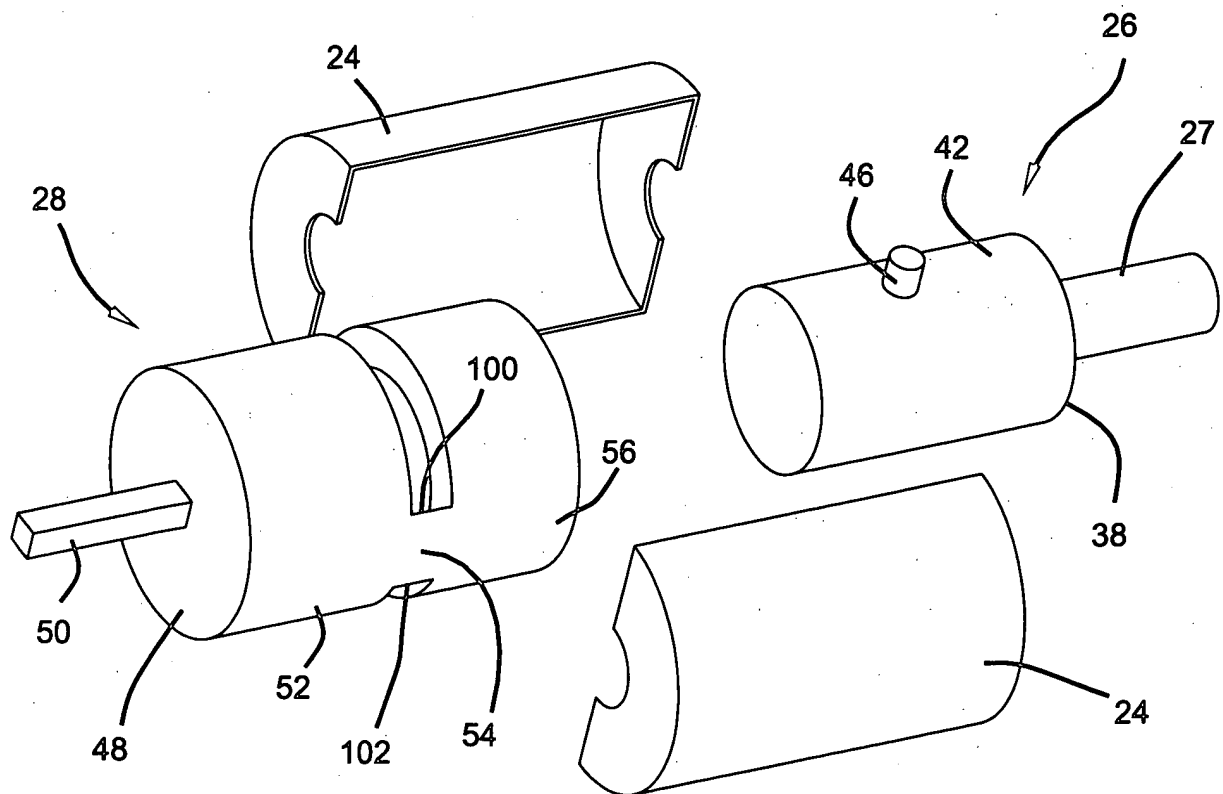


FIG 3

3/5

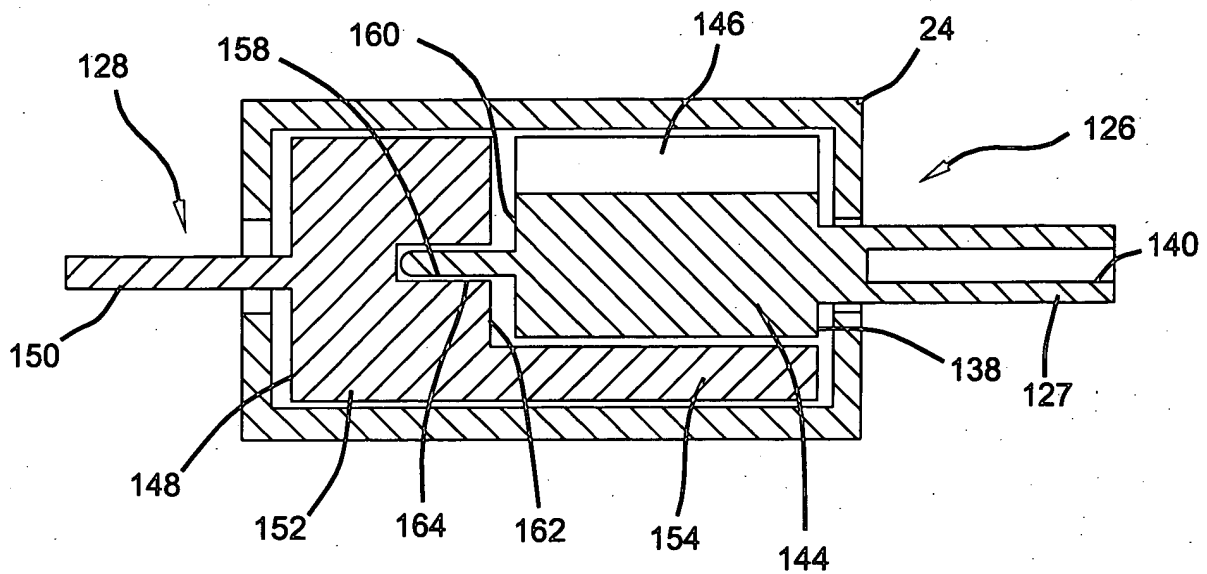


FIG 4

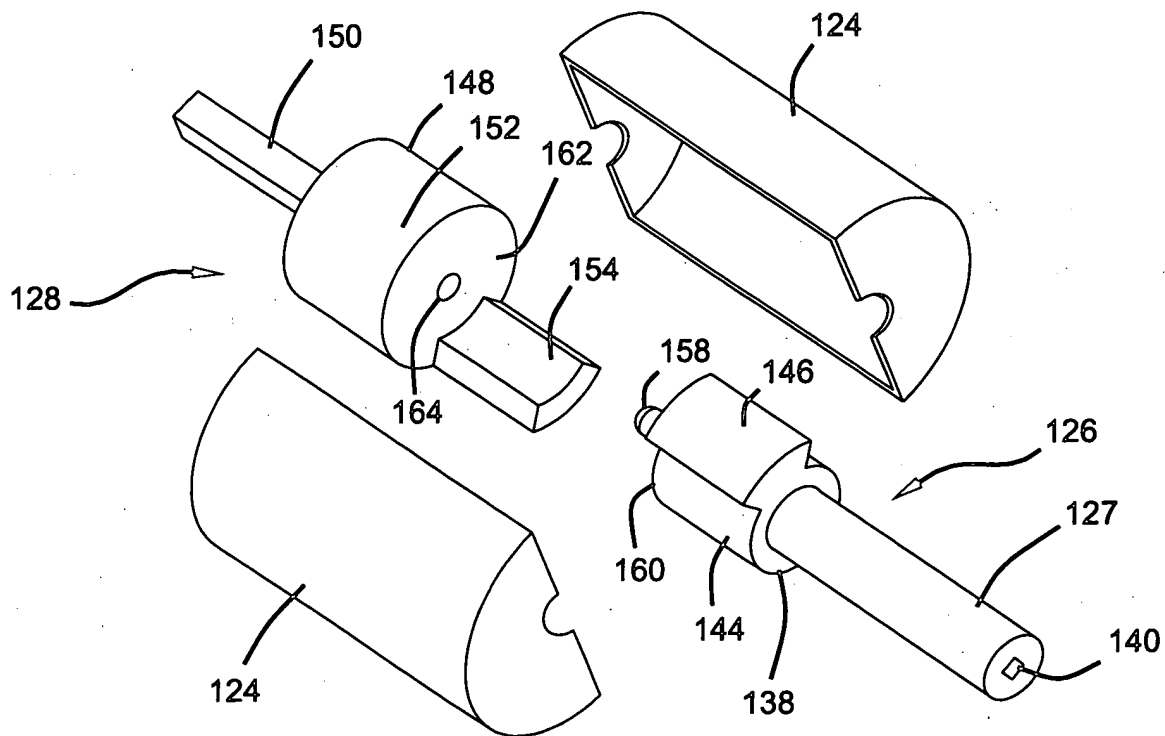


FIG 5

This cross-sectional view shows a multi-layered assembly. A central cavity (226) is formed within a substrate (224). The cavity is lined with a conductive material (228). A central conductive core (250) extends through the assembly. On the right side, a conductive pad (240) is connected to the central core. The assembly is surrounded by a protective layer (227). Other components labeled include 252, 262, 254, 224, 226, 228, 250, 238, 248, 284, 256, 244, and 227.

This diagram shows an exploded perspective view of a second embodiment of the device. It includes a cylindrical component 226 with a central shaft 227 and a flange 246. A rectangular plate 248 is positioned below it, featuring a semi-circular cutout 244 and two protruding pins 250 and 252. A separate component 224 is shown above the assembly, with a semi-circular notch 254 designed to align with the cutout 244. Other labels include 238, 256, 262, 266, and 284.

FIG 7

5/5

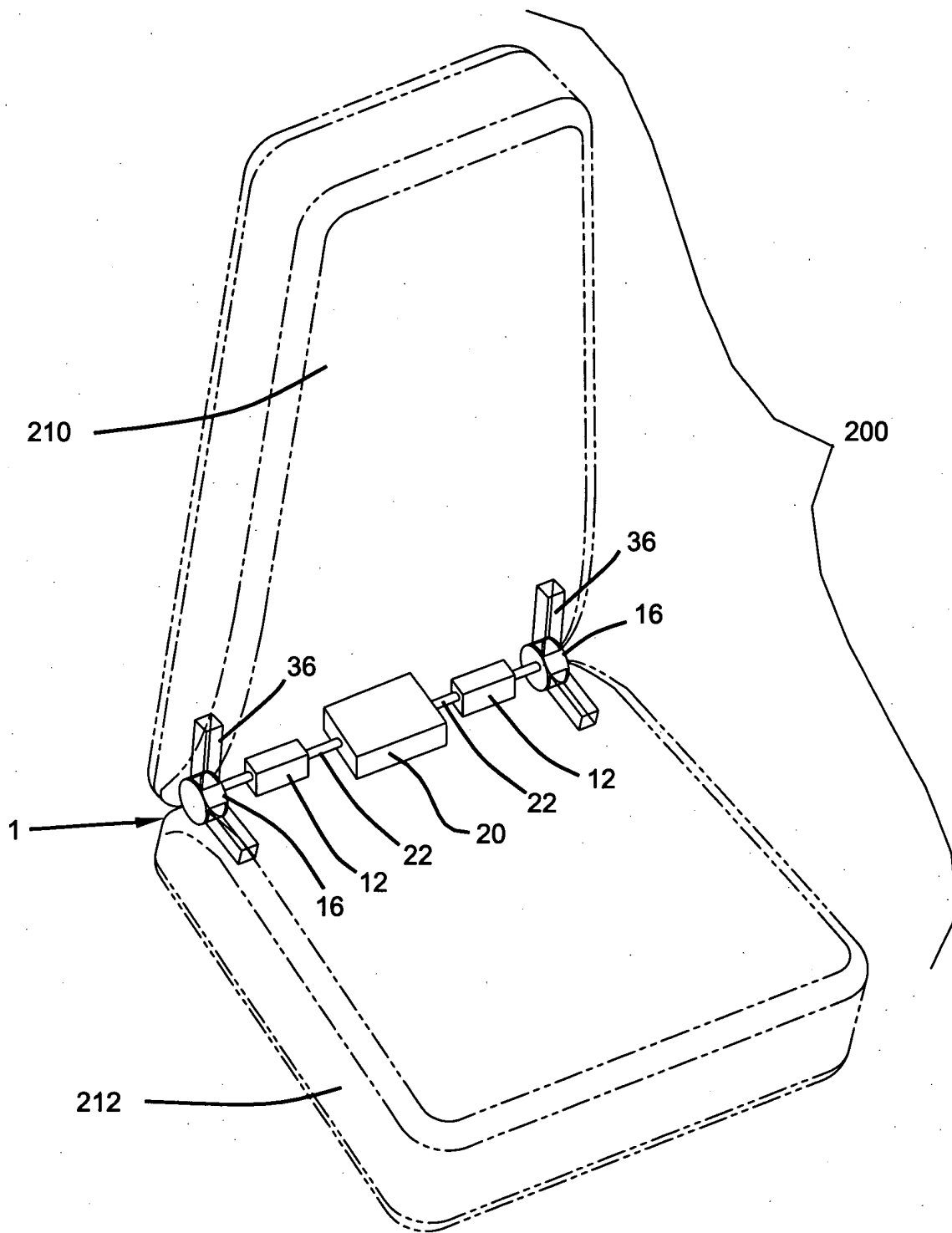


FIG 8